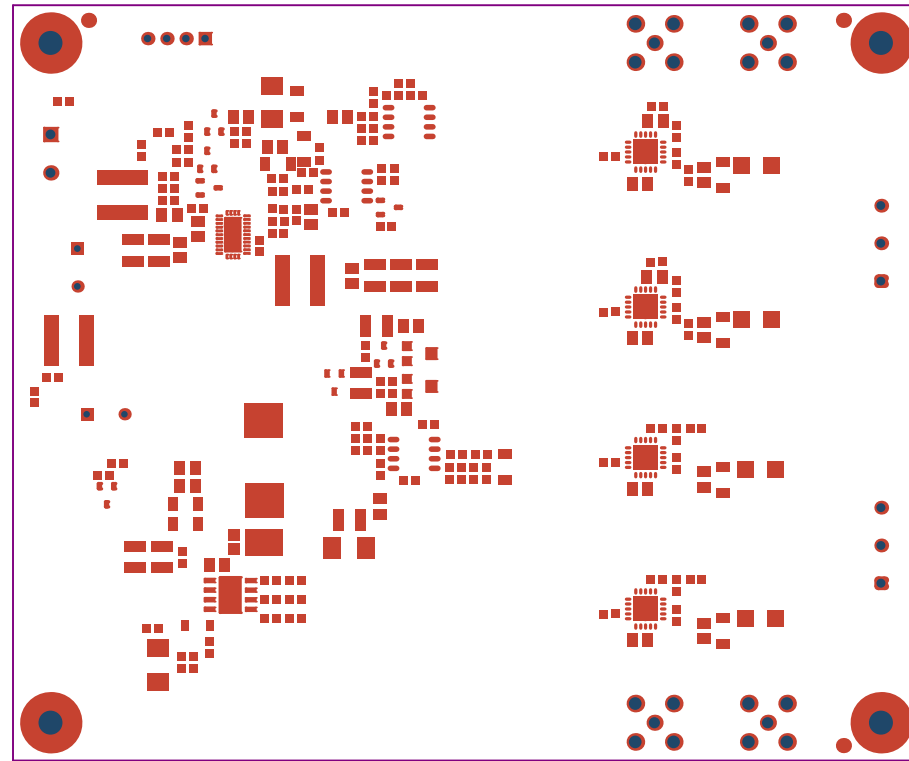
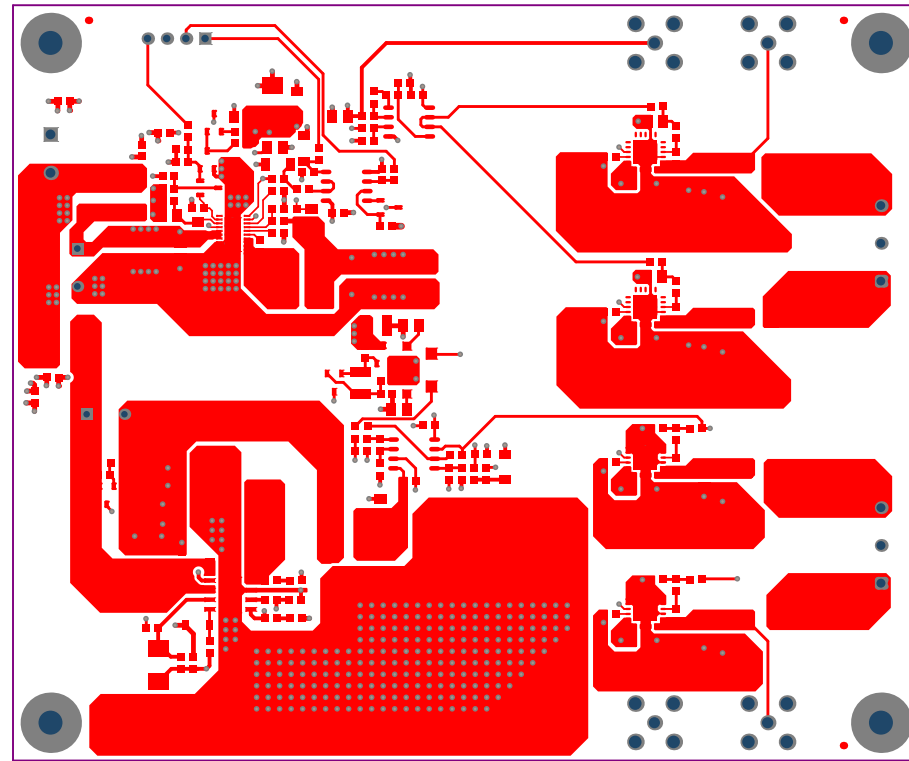


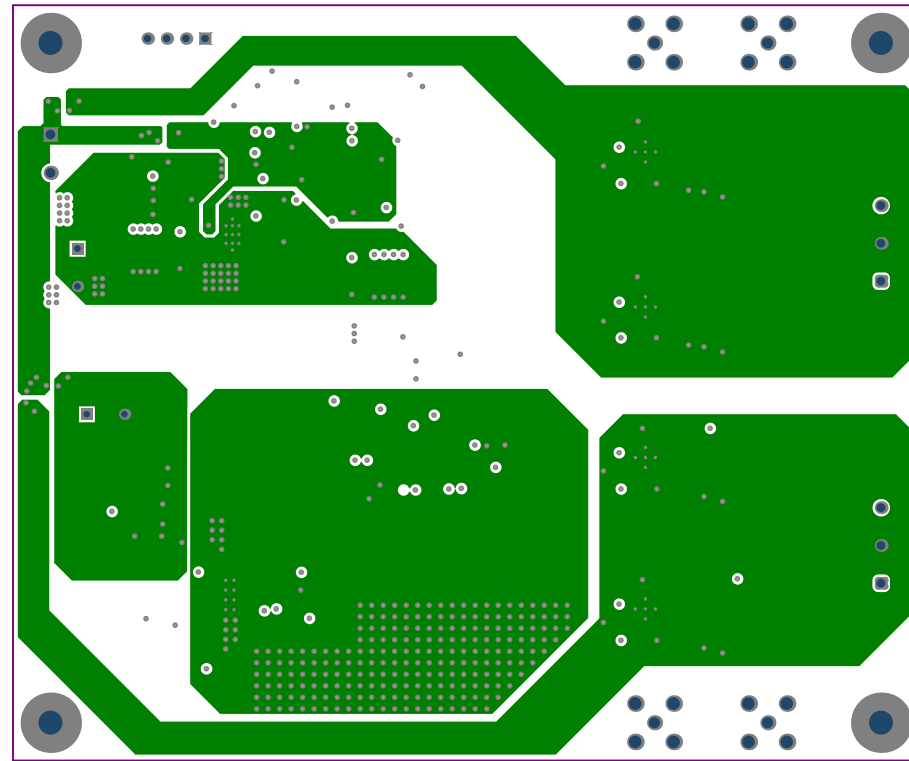
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01458	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: TIDA-01458		
PLOT NAME = Top Overlay	GENERATED : 8/23/2017 5:10:07 PM	TEXAS INSTRUMENTS	



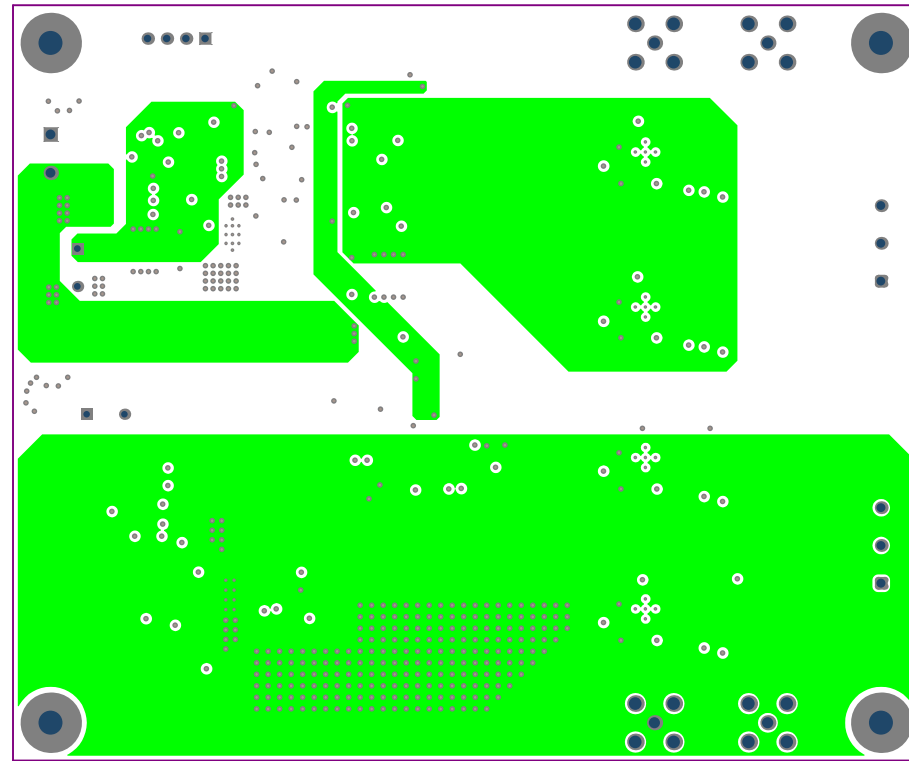
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01458	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: TIDA-01458		
PLOT NAME = Top Solder Mask	GENERATED : 8/23/2017 5:10:09 PM	TEXAS INSTRUMENTS	



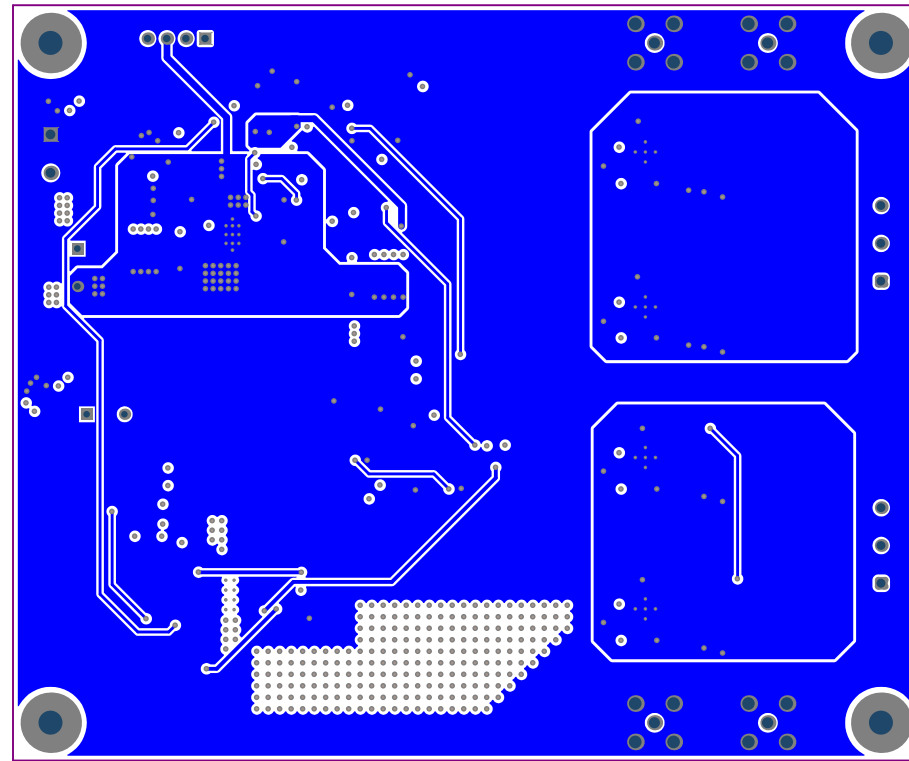
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01458	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #: TIDA-01458		
PLOT NAME = Top Layer	GENERATED : 8/23/2017 5:10:10 PM	TEXAS INSTRUMENTS	



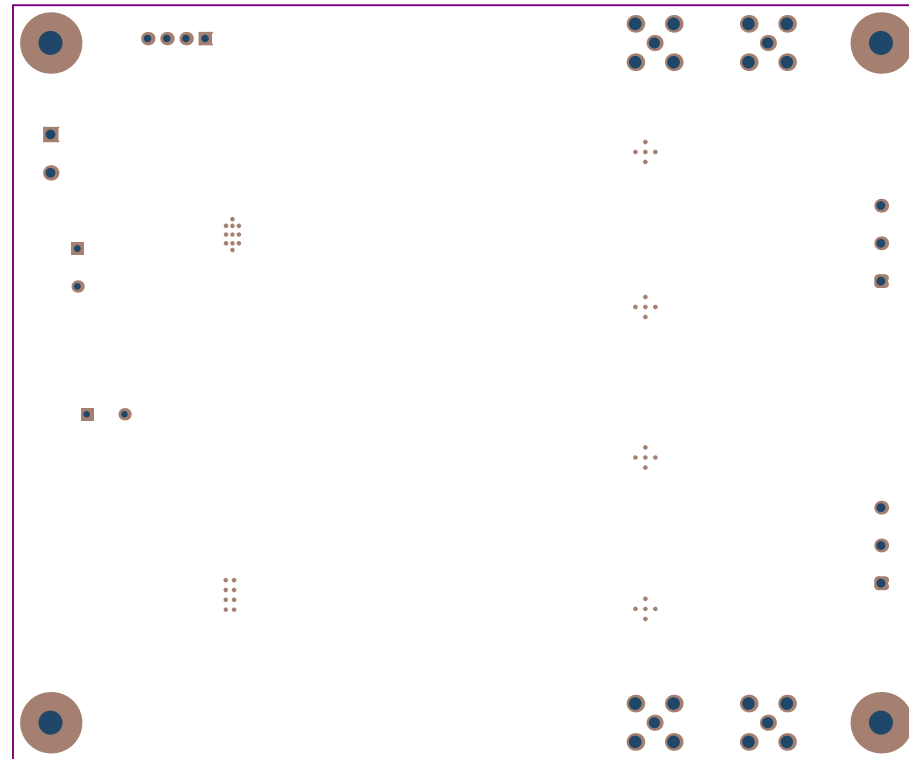
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01458	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = GND	TID #: TIDA-01458		
PLOT NAME = Signal Layer 1	GENERATED : 8/23/2017 5:10:11 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01458	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = PWR	TID #: TIDA-01458		
PLOT NAME = Signal Layer 2	GENERATED : 8/23/2017 5:10:13 PM	TEXAS INSTRUMENTS	



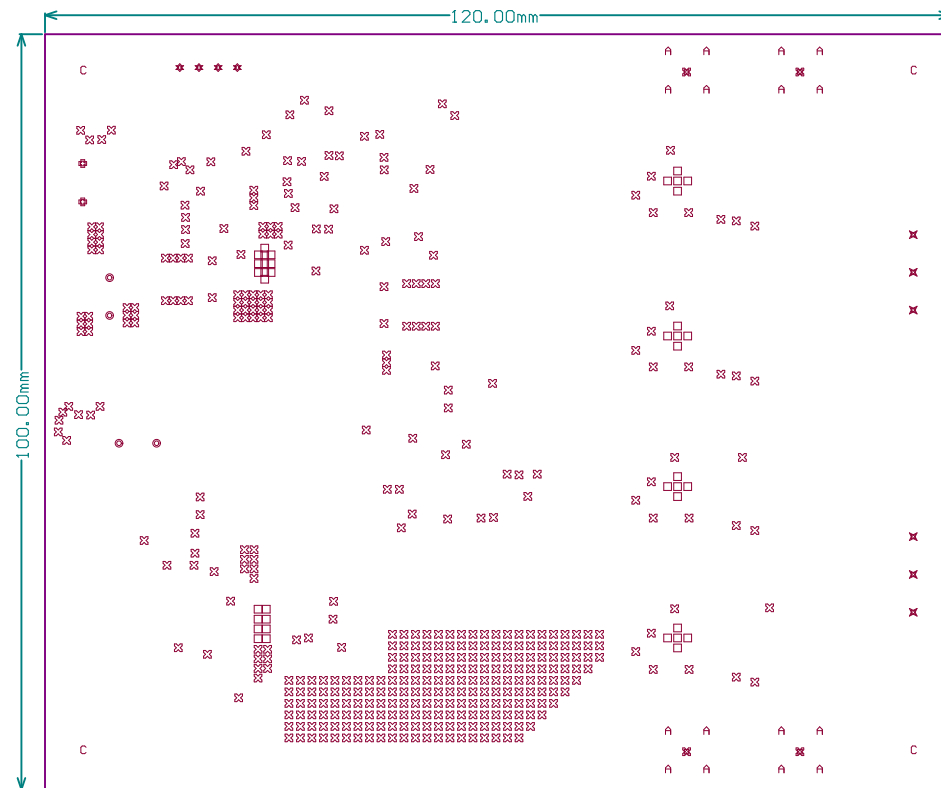
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01458	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #: TIDA-01458		
PLOT NAME = Bottom Layer	GENERATED : 8/23/2017 5:10:14 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01458	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: TIDA-01458		
PLOT NAME = Bottom Solder Mask	GENERATED : 8/23/2017 5:10:15 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01458	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #: TIDA-01458		
PLOT NAME = Bottom Overlay	GENERATED : 8/23/2017 5:10:16 PM	TEXAS INSTRUMENTS	



Symbol	Hit Count	Finished Hole Size	Plated	Hole Type
#	2	51.18mil (1.300mm)	PTH	Round
⊙	4	35.43mil (0.900mm)	PTH	Round
*	4	40.00mil (1.016mm)	PTH	Round
⊗	4	59.06mil (1.500mm)	PTH	Round
C	4	125.98mil (3.200mm)	PTH	Round
X	6	47.24mil (1.200mm)	PTH	Round
A	16	66.93mil (1.700mm)	PTH	Round
□	39	7.87mil (0.200mm)	PTH	Round
⊗	424	15.00mil (0.381mm)	PTH	Round
503 Total				

DRILL TABLE
 FOR 7.874MIL DRILL +0/-7.874MIL
 FOR 15MIL DRILL +0/-15MIL
 FOR PTH DRILL +/-3MIL

NOTE:
 15MIL Vias are Tented in both the sides.
 7.874MIL vias are not Tented.

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01458	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: TIDA-01458		
PLOT NAME = Drill Drawing	GENERATED : 8/23/2017 5:10:18 PM	TEXAS INSTRUMENTS	

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